



深圳市一众显示科技有限公司

SHEN ZHEN TEAM SOURCE DISPLAY TECH. CO, TD.

TFT-LCD Module Specification

Module NO.: TST28011T-02

Version: V1.1

APPROVAL FOR SPECIFICATION

APPROVAL FOR SAMPLE

For Customer' s Acceptance:	
Approved by	Comment

Team Source Display:		
Presented by	Reviewed by	Organized by

Version No.	Date	Content	Remark
V1.0	2019-3-22	Initial Release	
V1.1	2019-6-5	Changed the drive IC	

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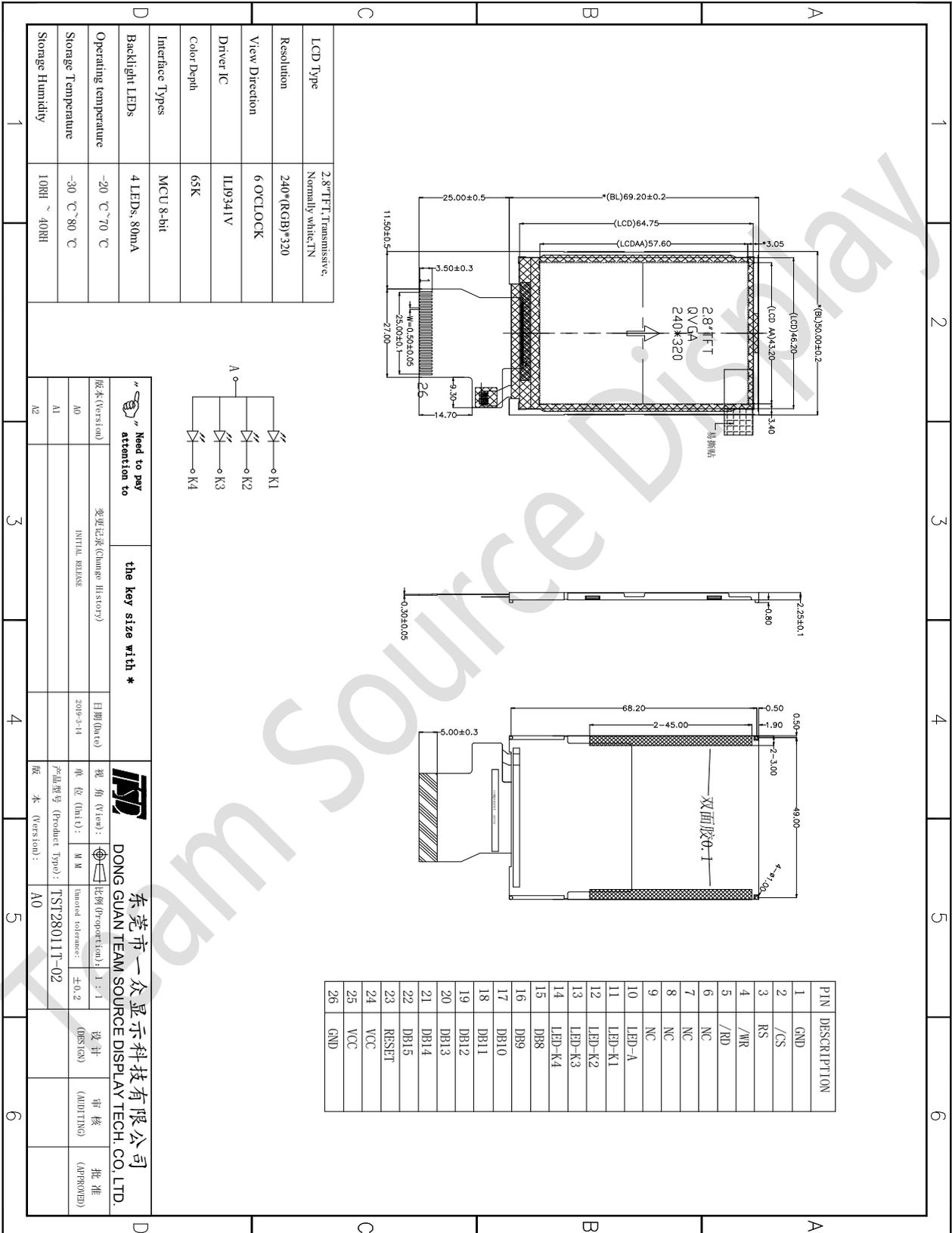
1 General Characteristics

ITEM	Specification	Unit
LCD Type	a-Si TFT, Transmissive, Normally white, TN	-
LCD Size	2.8	inch
Resolution (W x H)	240 x (RGB) x 320	pixel
LCM (W x H x D)	50.0(W) x 69.2(H) x 2.25(D)	mm
Active Area (W x H)	43.2 (W) x 57.6 (H)	mm
Dot Pitch (W x H)	0.180 (W) x 0.180 (H)	mm
Viewing Direction	6 o'clock	-
Gray Scale Inversion Direction	12 o'clock	-
Color Depth	65K	-
Pixel Arrangement	RGB Vertical stripe	-
Backlight Type	4 LEDs, 80mA	-
Surface Luminance	275	cd/m ²
Surface Treatment	Anti-Glare	-
Driver IC	ST7789V	-
Interface Type	MCU 8bit	-
Input Voltage	2.8	V
With/Without TP	without	-
Weight	TBD.	g

Note 1: RoHS compliant

Note 2: LCM weight tolerance: ± 5%.

2 Product drawings

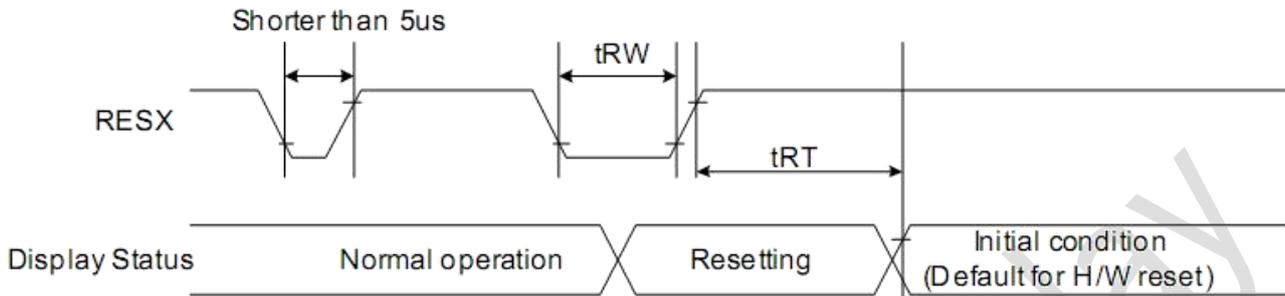


3 Interface description

PIN NO.	Symbol	description
1	GND	System Ground. (0V)
2	/CS	Chip select signal.
3	RS	Data/Command Selection pin
4	/WR	write signal
5	/RD	read signal
6-9	NC	NO connect
10	LED-A	Backlight A Anode input pin.
11	LED-K1	Backlight K Cathode input pin.
12	LED-K2	Backlight K Cathode input pin.
13	LED-K3	Backlight K Cathode input pin.
14	LED-K4	Backlight K Cathode input pin.
15-22	DB8-DB15	Data BUS
23	RESET	Reset input signal
24-25	VCC	Power supply
26	GND	System Ground. (0V)

4 LCM Interface Timing

4.1 Reset Timing

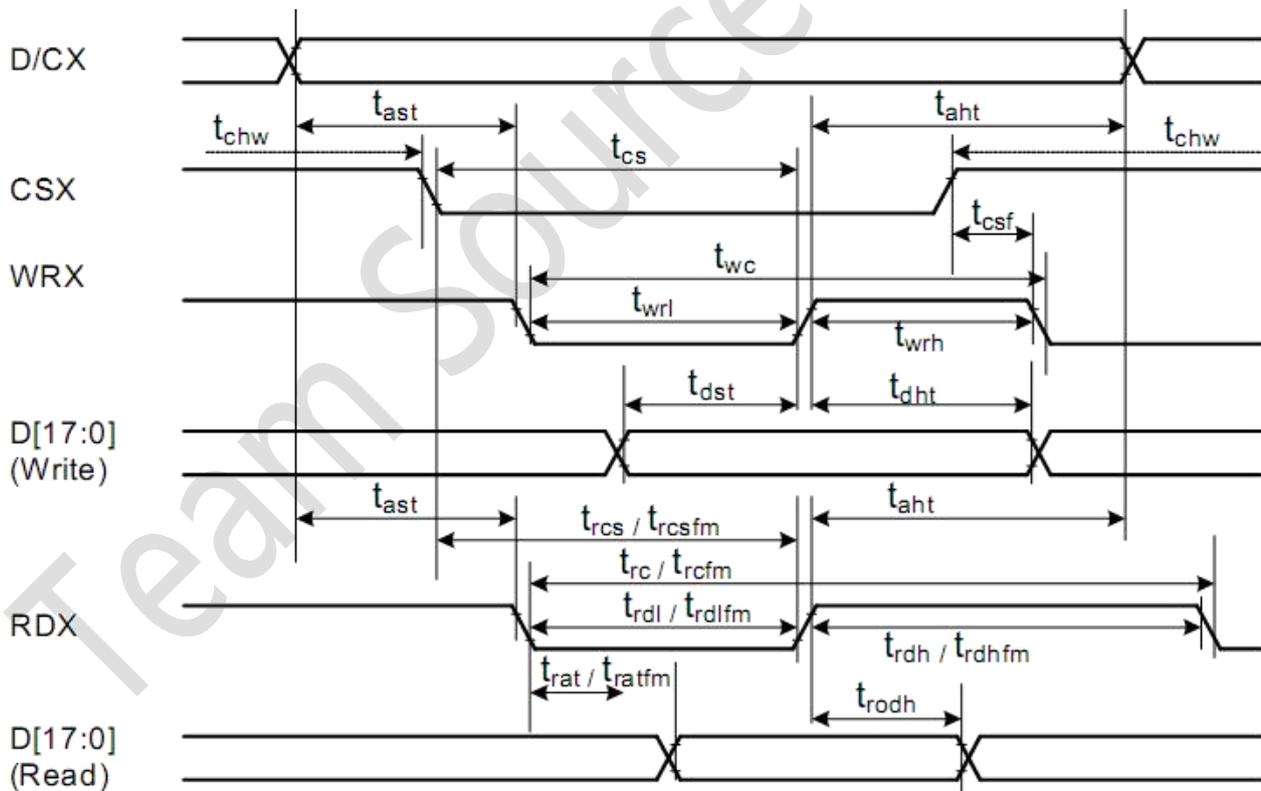


Signal	Symbol	Parameter	Min	Max	Unit
RESX	tRW	Reset low pulse width	10	-	us
	tRT	Reset complete time	-	5 (note 1)	ms
			-	120(note 2)	ms

Note: (1) When reset applied during SLPIN mode;

(2) When reset applied during SLPOUT mode.

4.2 MCU Read/Write Timing

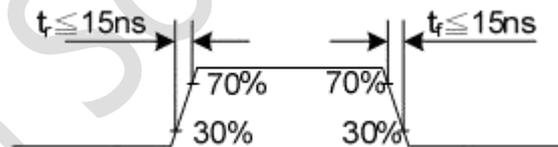


(Ta = 30 to 70 °C, IOVCC=1.65V to 3.3V, VCC=2.5V to 3.3V, VSS=0V)

Signal	Symbol	Parameter	min	max	Unit	Description
DCX	tAST	Address setup time	0	-	ns	-
	tAHT	Address hold time (Write/Read)	0	-		
CSX	tCS	Chip select setup time (Write)	15	-	ns	-
	tRCS	Chip select setup time (Read register)	45	-		
	tRCSFM	Chip select setup time (GRAM)	355	-		
	tCSF	Chip select wait time (Write/Read)	10	-		
WRX	tWC	Write cycle (write register)	66	-	ns	-
	tWRH	Control pulse "H" duration	15	-		
	tWRL	Control pulse "L" duration	15	-		
RDX	tRC	Read cycle (read register)	160	-	ns	-
	tRC	Read cycle (GRAM)	450	-		
	tRDH	Control pulse "H" duration	90	-		
	tRDL	Control pulse "L" duration(read register)	45	-		
	tRDL	Control pulse "L" duration(GRAM)	355	-		
DB[23:0]	tDST	Data setup time	10	-	ns	For maximum CL=30pF For minimum CL=8pF
	tDHT	Data hold time	10	-		
	tRAT	Read access time(read register)	-	40		
	tRAT	Read access time(GRAM)	-	340		
	tODH	Output disable time	20	80		

Note: The input signal rise time and fall time (tr, tf) is specified at 15 ns or less.

Logic high and low levels are specified as 30% and 70% of IOVCC for Input signals.



5 Absolute Maximum Ratings

PARAMETER	SYMBOL	MIN	MAX	UNIT
Supply Voltage (Analog)	VCC~GND	-0.3	4.6	V
Logic signal voltage(I/O)	IOVCC~GND	-0.3	4.6	V
Operating Temperature	Top	-20	70	° C
Storage Temperature	Tst	-30	80	° C
Operating Ambient Humidity	Hop	10	90%(Max 60° C)	RH

6 Electrical Characteristics

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
Analog operating voltage	VCC	2.5	2.8	3.3	V
Logic operating voltage	IOVCC	1.65	1.8	3.3	V
Input Current	IDD	-	TBD	-	mA
Input Voltage ' H ' level	VIH	0.7IOVCC	-	IOVCC	V
Input Voltage ' L ' level	VIL	GND	-	0.3IOVCC	
Output Voltage ' H ' level	VOH	0.8IOVCC	-	IOVCC	
Output Voltage ' L ' level	VOL	GND	-	0.2IOVCC	

7 Backlight Characteristics

ITEM	SYMBOL	MIN	TYP	MAX	UNIT
Voltage for LED backlight	V _f	-	3.2	3.4	V
Current for LED backlight	I _f	-	80	-	mA
Power consumption	W _{bl}	-	256	-	mW
Uniformity	Avg	80	-	-	%
LED Life Time	-	30000	40000	-	Hrs

Note:

1. The LED life time is defined as the module brightness decrease to 50% original brightness at Ta=25°C, 60%RH ±5 %.
2. The life time of LED will be reduced if LED is driven by high current, high ambient temperature and humidity conditions.
3. Typical operating life time is an estimated data.
4. Permanent damage to the device may occur if maximum values are exceeded or reverse voltage is loaded .Functional operation should be restricted to the conditions described under normal operating conditions.

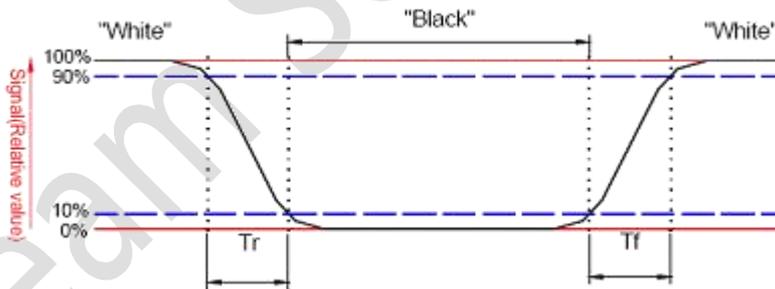
8 LCD Optical specifications

Item	Symbol	Condition	Specification			Unit	Remark
			Min	Typ	Max		
Response time (By Quick)	Tr+Tf	-	-	30	40	ms	Note 2
Contrast ratio	CR	-	400	500	-	-	Note 3
Surface luminance	Lv	$\theta=0^\circ$	220	275	-	Cd/m ²	Note 4
Luminance uniformity	Yu	$\theta=0^\circ$	80	-	-	%	Note 6
NTSC	-	$\theta=0^\circ$	-	30	-	%	Note 6
Viewing angle	Top	$CR \geq 10$	-	65	-	Deg.	Note 7
	Bottom	$CR \geq 10$	-	60	-		
	Left	$CR \geq 10$	-	60	-		
	Right	$CR \geq 10$	-	30	-		
CIE(x,y) chromaticity	Wx	$\theta=0^\circ$	Typ -0.03	0.308	Typ +0.03		Note 5
	Wy			0.333			
	Rx			0.641			
	Ry			0.337			
	Gx			0.274			
	Gy			0.560			
	Bx			0.141			
	By			0.113			

Note 1: Ambient temperature = 25°C.

Note 2: Definition of response time:

The output signals of TRD-100 are measured when the input signals are changed to “White” (falling time) and from “White” to “Black” (rising time), respectively. The interval is between the 10% and 90% of amplitudes. Refer to figure as below.



Note 3: Definition of contrast ratio:

Contrast ratio is calculated by the following formula.

$$\text{Contrast ratio (CR)} = \frac{\text{Brightness on the "white" state}}{\text{Brightness on the "black" state}}$$

Measured at the center area of the LCD.

Note 4: Definition of surface luminance

Surface luminance is the luminance with all pixels displaying white

Note 5: For contrast ratio, Surface Luminance, Luminance uniformity and CIE,the testing data is base on TOPCON' s BM-7 photo detector or compatible.

Size : $S \leq 4.3''$ (see Figure A B)

H,V : Active area

Light spot size=7.7mm (BM-7)50cm distance or compatible distance from the LCD surface to detector lens.

test spot position : see Figure B.

measurement instrument : TOPCON' s luminance meter BM-7 or compatible.

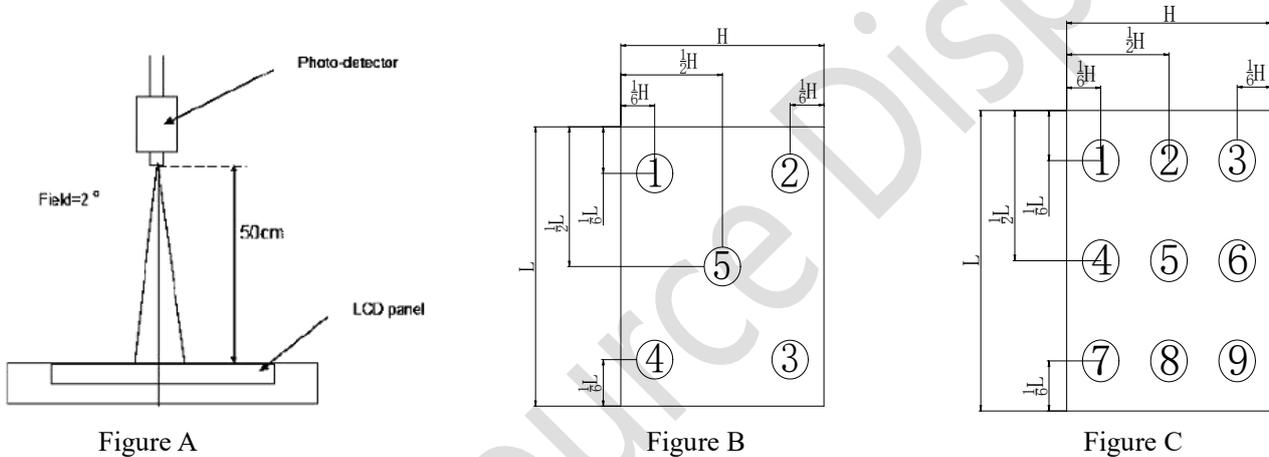
Size : $4.3 < S \leq 12.3''$ (see Figure A C)

H,V : Active area

Light spot size=7.7mm (BM-7)50cm distance or compatible distance from the LCD surface to detector lens.

test spot position : see Figure C.

measurement instrument : TOPCON' s luminance meter BM-7 or compatible.



Note 6:Definition of Luminance Uniformity

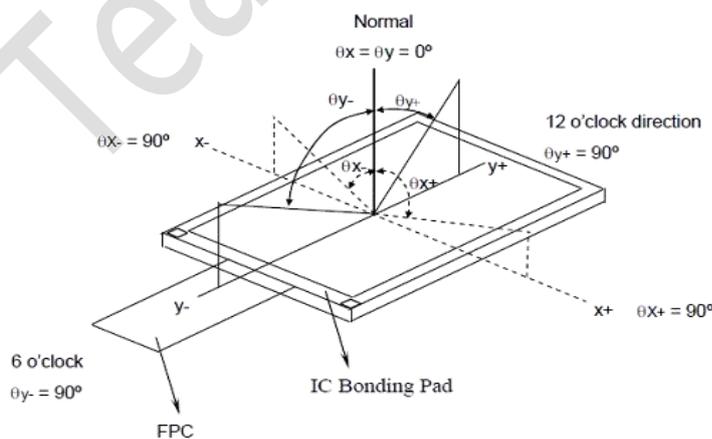
Active area is divided into 5 or 9 measuring areas,Every measuring point is placed at the center of each measuring area

Bmax: The measured maximum luminance of all measurement position.

Bmin: The measured minimum luminance of all measurement position.

Luminance Uniformity (Yu)= (Bmin/Bmax)x100%

Note 7: Definition of viewing angle



9 RELIABILITY TEST

NO.	TEST ITEM	TEST CONDITION	INSPECTION AFTER TEST
1	High Temperature Storage	80±2°C/96 hours	Inspection after 2~4 hours storage at room temperature and humidity. The condensation is not accepted. The sample shall be free from defects: 1. Air bubble in the LCD 2. Seal leak 3. Non-display 4. Missing segments 5. Glass crack
2	Low Temperature Storage	-30±2°C/96 hours	
3	High Temperature Operating	70±2°C/96 hours	
4	Low Temperature Operating	-20±2°C/96 hours	
5	Temperature Cycle	-30±2°C ~ 25~ 80± 2°C × 10 cycles (30 min.) (5min.) (30min.)	
6	Damp Proof Test	60°C ±5°C × 90%RH/96 hours	
7	Vibration Test	Frequency 10Hz~55Hz Stroke: 1.5mm Sweep: 10Hz~150 Hz~10Hz 2 hours For each direction of X, Y, Z	
8	Packing Drop Test	Height: 50 cm 1 corner, concrete floor	
9	Electrostatic Discharge Test	C=150pF, R=330 Ω Air: ±8KV 150pF/330Ω 30 times Contact: ±4KV,20 times	

10 Suggestions for using LCD modules

10.1 Handling of LCM

1. The LCD screen is made of glass. Don't give excessive external shock, or drop from a high place.
2. If the LCD screen is damaged and the liquid crystal leaks out, do not lick and swallow. When the liquid is attach to your hand, skin, cloth etc, wash it off by using soap and water thoroughly and immediately.
3. Don't apply excessive force on the surface of the LCM.
4. If the surface is contaminated, clean it with soft cloth. If the LCM is severely contaminated, use Isopropyl alcohol/Ethyl alcohol to clean. Other solvents may damage the polarizer. The following solvents is especially prohibited: water , ketone Aromatic solvents etc.
5. Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
6. Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
7. Don't disassemble the LCM.
8. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Be sure to ground the body when handling the LCD modules.
 - Tools required for assembling, such as soldering irons, must be properly grounded.
 - To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions.
 - The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
9. Do not alter, modify or change the the shape of the tab on the metal frame.
10. Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
11. Do not damage or modify the pattern writing on the printed circuit board.
12. Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector
13. Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
14. Do not drop, bend or twist LCM.

10.2 Storage

1. Store in an ambient temperature of 5 to 45 C, and in a relative humidity of 40% to 60%. Don't expose to sunlight or fluorescent light.
2. Storage in a clean environment, free from dust, active gas, and solvent.
3. Store in antistatic container.

